

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Koichi Shibayama et al.

Application No.: 10/582,881

Confirmation No.: 8694

Filed: June 14, 2006

Art Unit: 4171

For: THERMOSETTING RESIN COMPOSITION,
MATERIAL FOR SUBSTRATE AND FILM
FOR SUBSTRATE

Examiner: Darcy Danielle LaClair

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the non-final Office Action dated July 18, 2008, please amend the above-identified U.S. patent application as follows:

Amendments to the Specification begin on page 2.

Amendments to the Claims are reflected in the listing of claims which begins on page 5 of this paper.

Remarks/Arguments begin on page 7 of this paper.